

Parameter	Tr1 and Tr2
V_{CC}	-50V
$I_C(\text{MAX.})$	-100mA
R_1	10k Ω
R_2	10k Ω

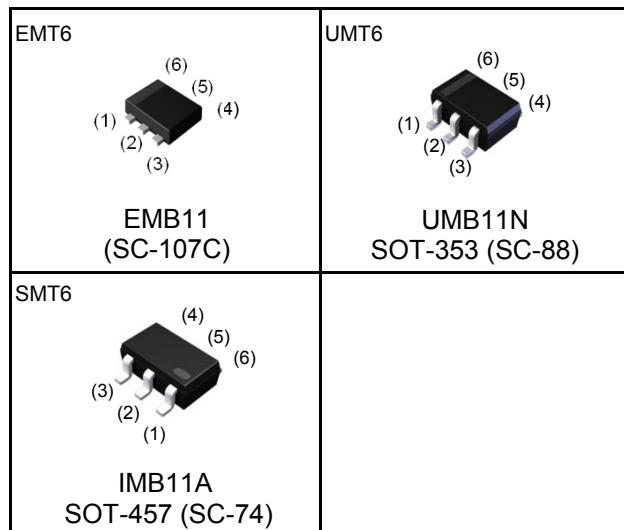
●Features

- 1) Built-In Biasing Resistors, $R_1 = R_2 = 10k\Omega$.
- 2) Two DTA114E chips in one package.
- 3) Built-in bias resistors enable the configuration of an inverter circuit without connecting external input resistors (see inner circuit).
- 4) The bias resistors consist of thin-film resistors with complete isolation to allow negative biasing of the input. They also have the advantage of completely eliminating parasitic effects.
- 5) Only the on/off conditions need to be set for operation, making the circuit design easy.
- 6) Lead Free/RoHS Compliant.

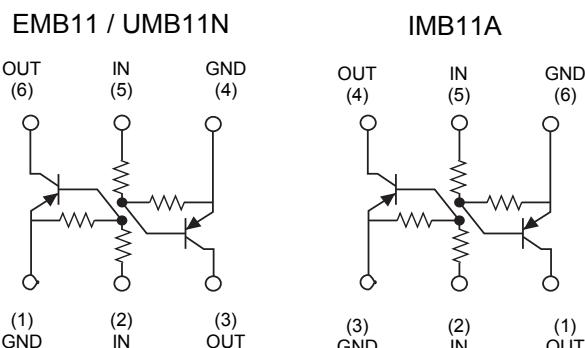
●Application

Inverter circuit, Interface circuit, Driver circuit

●Outline



●Inner circuit



●Packaging specifications

Part No.	Package	Package size (mm)	Taping code	Reel size (mm)	Tape width (mm)	Basic ordering unit (pcs)	Marking
EMB11	EMT6	1616	T2R	180	8	8,000	B11
UMB11N	UMT6	2021	TN	180	8	3,000	B11
IMB11A	SMT6	2928	T110	180	8	3,000	B11

● Absolute maximum ratings (Ta = 25°C)

<For Tr1 and Tr2 in common>

Parameter	Symbol	Values	Unit
Supply voltage	V _{CC}	-50	V
Input voltage	V _{IN}	-40 to +10	V
Output current	I _O	-50	mA
Collector current	I _{C(MAX.)} ^{*1}	-100	mA
Power dissipation	P _D ^{*2}	150 (Total) ^{*3}	mW
		300 (Total) ^{*4}	mW
Junction temperature	T _j	150	°C
Range of storage temperature	T _{stg}	-55 to +150	°C

● Electrical characteristics(Ta = 25°C)

<For Tr1 and Tr2 in common>

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
Input voltage	V _{I(off)}	V _{CC} = -5V, I _O = -100μA	-	-	-0.5	V
	V _{I(on)}	V _O = -0.3V, I _O = -10mA	-3.0	-	-	
Output voltage	V _{O(on)}	I _O / I _I = -10mA / -0.5mA	-	-0.1	-0.3	V
Input current	I _I	V _I = -5V	-	-	-0.88	mA
Output current	I _{O(off)}	V _{CC} = -50V, V _I = 0V	-	-	-0.5	μA
DC current gain	G _I	V _O = -5V, I _O = -5mA	20	-	-	-
Input resistance	R _I	-	7	10	13	kΩ
Resistance ratio	R ₂ /R ₁	-	0.8	1	1.2	-
Transition frequency	f _T ^{*1}	V _{CE} = -10V, I _E = 5mA, f = 100MHz	-	250	-	MHz

*1 Characteristics of built-in transistor

*2 Each terminal mounted on a reference footprint

*3 120mW per element must not be exceeded.

*4 200mW per element must not be exceeded.

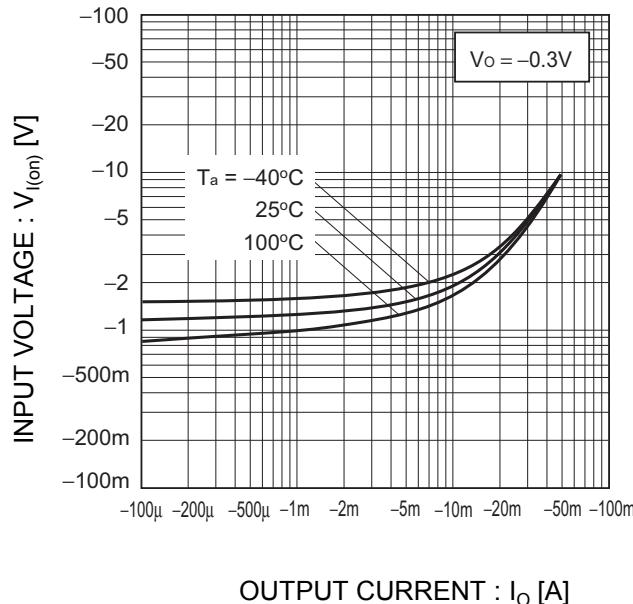
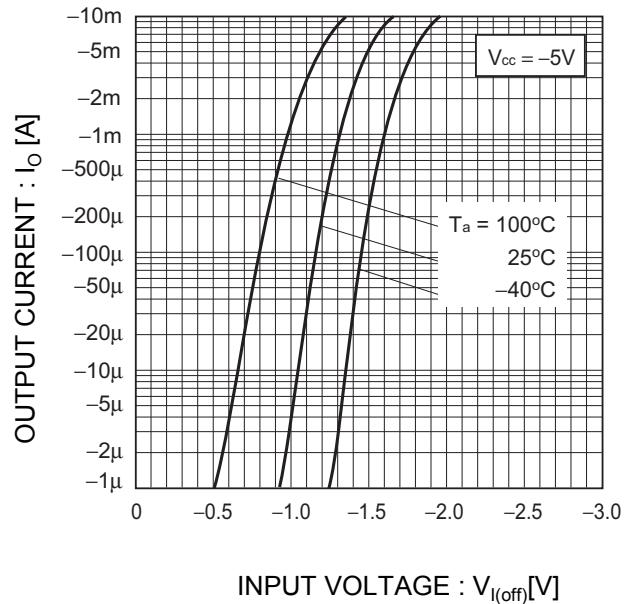
●Electrical characteristic curves($T_a = 25^\circ\text{C}$)Fig.1 Input voltage vs. output current
(ON characteristics)Fig.2 Output current vs. input voltage
(OFF characteristics)

Fig.3 Output current vs. output voltage

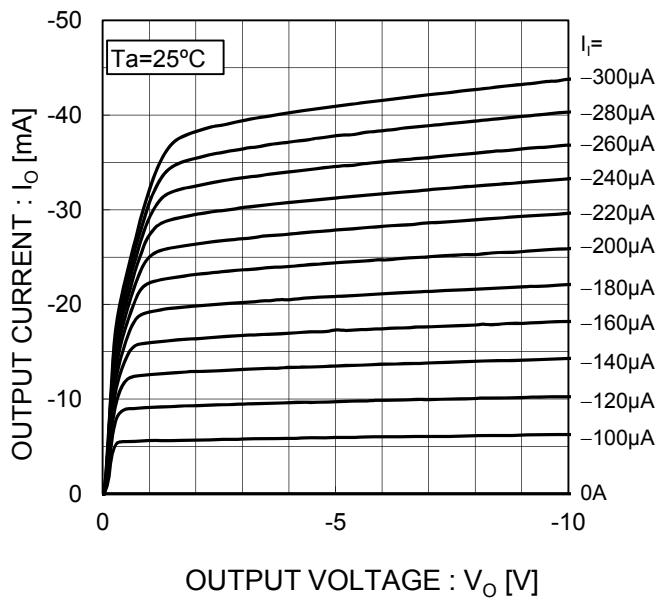
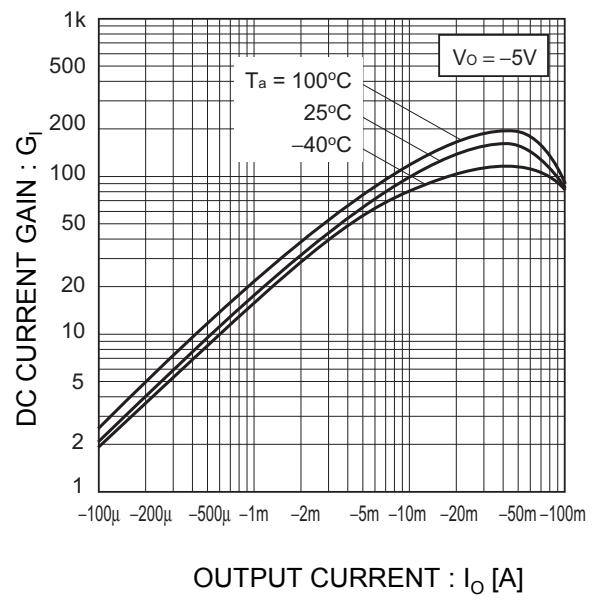
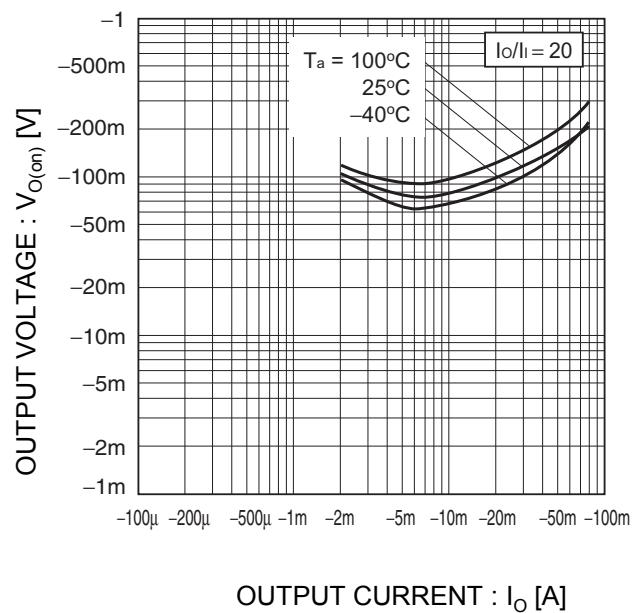


Fig.4 DC current gain vs. output current



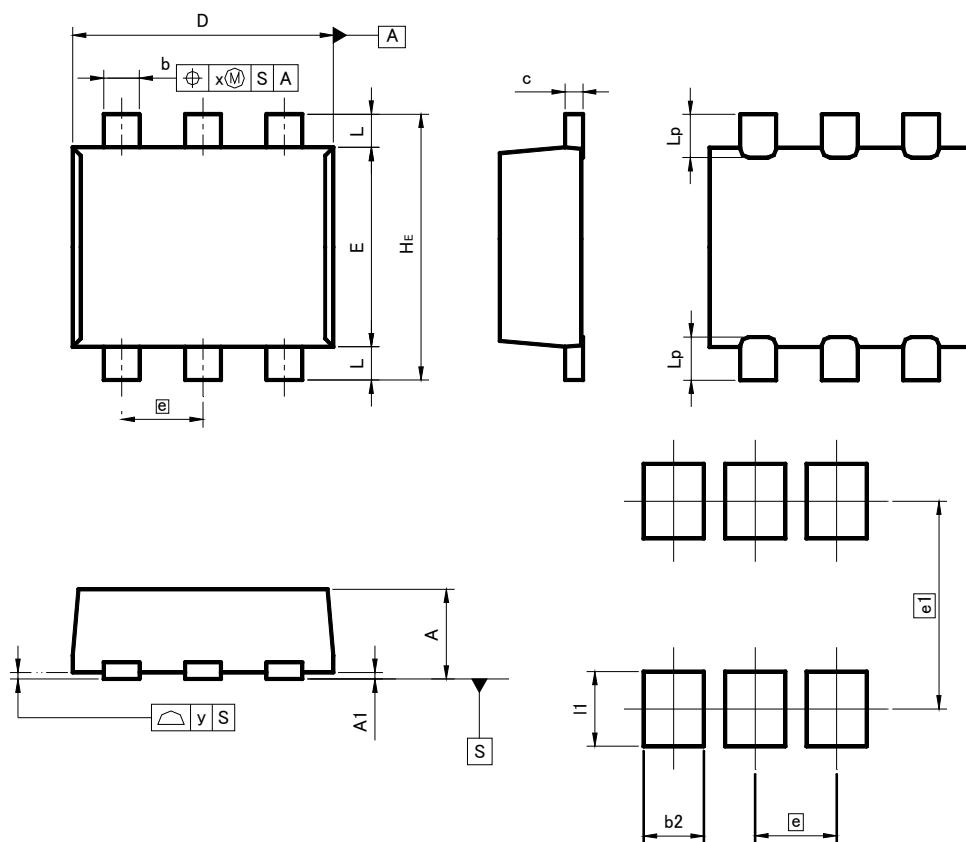
●Electrical characteristic curves($T_a = 25^\circ C$)

Fig.5 Output voltage vs. output current



●Dimensions (Unit : mm)

EMT6

Pattern of terminal position areas

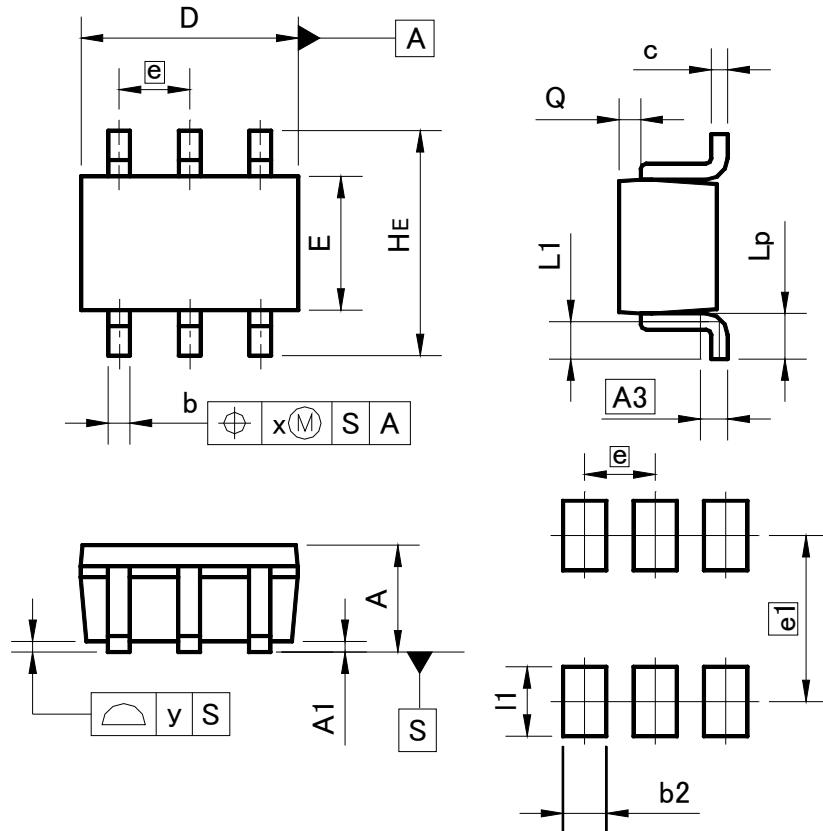
DIM	MILIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A1	0.00	0.10	0	0.004
A	0.45	0.55	0.018	0.022
b	0.17	0.27	0.007	0.011
c	0.08	0.18	0.003	0.007
D	1.50	1.70	0.059	0.067
E	1.10	1.30	0.043	0.051
e	0.50		0.02	
He	1.50	1.70	0.059	0.067
L	0.10	0.30	0.004	0.012
Lp	—	0.35	—	0.014
x	—	0.10	—	0.004
y	—	0.10	—	0.004

DIM	MILIMETERS		INCHES	
	MIN	MAX	MIN	MAX
e1	1.25		0.049	
b2	—	0.37	—	0.015
l1	—	0.45	—	0.018

Dimension in mm/inches

●Dimensions (Unit : mm)

UMT6



Pattern of terminal position areas

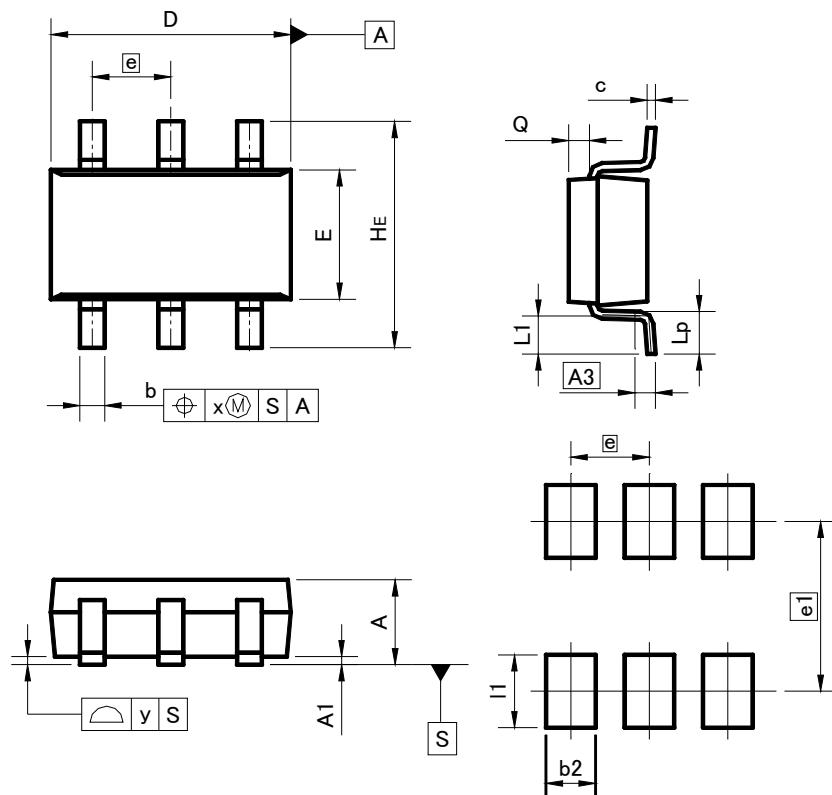
DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	0.80	1.00	—	0.039
A1	0.00	0.10	0	0.004
A3	0.25		0.01	
b	0.15	0.30	0.006	0.012
c	0.10	0.20	0.004	0.008
D	1.90	2.10	0.075	0.083
E	1.15	1.35	0.045	0.053
e	0.65		0.03	
HE	2.00	2.20	0.079	0.087
L1	0.20	0.50	0.008	0.02
Lp	0.25	0.55	0.01	0.022
Q	0.10	0.30	0.004	0.012
x	—	0.10	—	0.004
y	—	0.10	—	0.004

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
e1	1.55		0.06	
b2	—	0.40	—	0.016
l1	—	0.65	—	0.026

Dimension in mm/inches

●Dimensions (Unit : mm)

SMT6

Pattern of terminal position areas

DIM	MILIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	1.00	1.30	0.039	0.051
A1	0.00	0.10	0	0.004
A3	0.25		0.01	
b	0.25	0.40	0.01	0.016
c	0.09	0.25	0.004	0.01
D	2.80	3.00	0.11	0.118
E	1.50	1.80	0.059	0.071
e	0.95		0.04	
H _E	2.60	3.00	0.102	0.118
L ₁	0.30	0.60	0.012	0.024
L _p	0.40	0.70	0.016	0.028
Q	0.20	0.30	0.008	0.012
x	—	0.20	—	0.008
y	—	0.10	—	0.004

DIM	MILIMETERS		INCHES	
	MIN	MAX	MIN	MAX
e ₁	2.10		0.08	
b ₂	0.60		—	
l ₁	—		0.035	

Dimension in mm/inches

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